Electronic Version v1.1 Stylesheet Version v1.1

SUBMISSION TYPE:	NEW ASSIGNMENT	
NATURE OF CONVEYANCE:	ASSIGNMENT	

CONVEYING PARTY DATA

Name	Execution Date
No Sun Park	08/26/2009
Young Suk Chung	08/26/2009
Jae Beom Shim	08/26/2009

RECEIVING PARTY DATA

Name:	Amkor Technology, Inc.	
Street Address:	1900 South Price Road	
City:	Chandler	
State/Country:	ARIZONA	
Postal Code:	85286-6604	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	12549083

CORRESPONDENCE DATA

Fax Number: (831)655-0888

Correspondence will be sent via US Mail when the fax attempt is unsuccessful.

Phone: (831)655-0880
Email: ry@gunnisonlaw.com

Correspondent Name: Gunnison, McKay & Hodgson, L.L.P.

Address Line 1: 1900 Garden Road

Address Line 2: Garden West Office Plaza, Suite 220
Address Line 4: Monterey, CALIFORNIA 93940

ATTORNEY DOCKET NUMBER:	GK0040	
NAME OF SUBMITTER:	Serge J. Hodgson	

Total Attachments: 2

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PATENT REEL: 023158 FRAME: 0350 12549083

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PATENT REEL: 023158 FRAME: 0351

ASSIGNMENT

For good and valuable consideration, receipt of which is hereby acknowledged, I,

No Sun Park

#304-401 Eunvit Apt., Sanggye 1-dong,

Nowon-gu, Seoul, Korea

Young Suk Chung

#7-501, Gyeongnam Apt., Bangbae 3-dong,

Seocho-gu, Seoul, Korea

Jae Beom Shim

#711-1102, Jugong Apt., Bugae 2-dong,

Bupyeong-gu, Incheon, Korea

hereby sell, assign and transfer to Amkor Technology, Inc., a Delaware corporation, having a place of business at 1900 South Price Road, Chandler, AZ 85286-6604, its successors and assigns, the entire right, title and interest throughout the world in my invention in

WAFER LEVEL CHIP SIZE PACKAGE AND METHOD OF MANUFACTURING THE SAME

for which I have executed a United States patent application on or about the date of this assignment, and all patent applications and patents of every country for said invention, including divisions, reissues, continuations and extensions thereof, and all rights of priority resulting from the filing of said applications; I authorize the above-named assignee to apply for patents of foreign countries for said invention, and to claim all rights of priority without further authorization from me; I agree to execute all papers useful in connection with said United States and foreign applications, and generally to do everything possible to aid said assignee, its successors, assigns and nominees, at their request and expense, in obtaining and enforcing patents for said invention in all countries; and I request the Commissioner of Patents and Trademarks to issue all patents granted for said invention to the above-named assignee, its successors and assigns.

Executed this ______ day of ____ Aug

NO SUN P (Full Name

Witnessed by:

Signature

Date

Executed this _	26	_ day of	Aug.	_, 2009
			Witnessed by:	YOUNG SUK CHUNG (Full Name) Signature Aug 26 th., 2009 Date Da Hyun Na Printed Name
Executed this _	26	_ day of _.	Aug	_, 2009 Atry
			Witnessed by:	JAE BEOM SHIM (Full Name) Signature Aug 26th, 2009 Date Printed Name

RECORDED: 08/27/2009